

# ST763A series

### 3.3V Step down current mode PWM DC-DC converters

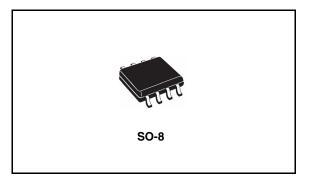
### Features

- Output voltage 3.3V
- Supply voltage range from 3.3V to 11V
- Guaranteed output current: 500mA
- Typical operation frequency: 200KHz
- Very low quiescent current: 0.6mA on mode 0.2µA OFF MODE
- Switch ON/OFF control
- Typical efficiency: 90%
- Operating temperature range: -40°C to 85°C
- Available in SO-8 package

### Description

The ST763A is a step-down switching regulator. It operates from 3.3V to 11V giving a fixed 3.3V output voltage, delivering up to 500mA. The mainly features are typical efficiency of 90%, quiescent current of 0.6mA, and only 0.2µA in shut-down.

The PWM current mode control provides precise output regulation and very good transient response. Output voltage accuracy is guaranteed to be ±5% over line, load and temperature



variations. A minimum number of external components is used and the fixed frequency switching allows easy filtering of output ripple and noise.

Other features of this device are cycle-by-cycle current limiting, overcurrent limiting, under voltage lockout and programmable soft-start protection.

A 22µH inductor works in most applications, so no sophisticated design is necessary.

Package available is SO-8.

Typical application are in 5V to 3.3V converters, cellular phones, portable instruments, hand-held computers, and peripherals.

### Order code

	Part number	Packaging		
	ST763AC	ST763ACDTR		
May 2007 Re		v. 3 1/14		

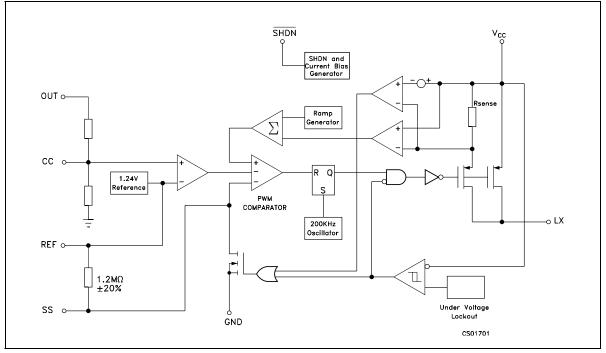
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## 1 Diagram





## 2 Pin configuration

### Figure 2. Pin connections (top view)

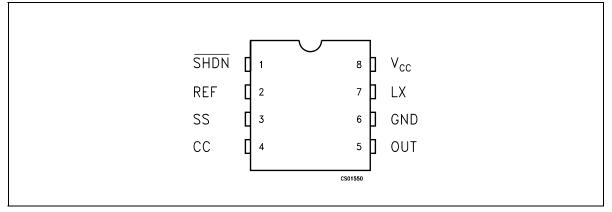


Table 1.   Pin description				
Pin N°	Symbol	Name and function		
1	SHDN	Shutdown control (active low): If connected to GND the IC is in shutdown. Connect to $V_{\rm CC}$ for normal operation (ON MODE).		
2	REF	Reference output voltage: (1.25V): Bypass to GND with 47nF capacitor.		
3	SS	Soft start: a capacitor between SS and GND provides soft-start and short-circuit protections.		
4	СС	Compensation capacitor input: externally compensates the outer (voltage) feedback loop. Connect to OUT with 330pF capacitor		
5	OUT	Output voltage sense input: provides regulation of feedback sensing. Connect to 3.3V output.		
6	GND	Ground		
7	LX	Switch output. Drain of internal P-channel power MOSFET		
8	V <sub>CC</sub>	Supply voltage input. Bypass to GND with 1 $\mu$ F ceramic capacitance and large value electrolytic capacitor in parallel. The 1 $\mu$ F capacitor must be as close as possible to the GND and V <sub>CC</sub> pins.		



## 3 Maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	DC input voltage	-0.3 to 12	V
$V_{LX}$	Switch pin voltage	-0.3 to (V <sub>CC</sub> + 0.3)	V
V <sub>SHDN</sub>	Shutdown voltage (SHDN)	-0.3 to (V <sub>CC</sub> + 0.3)	V
$V_{S}, V_{C}$	Soft start (SS) and compensation capacitor (C	-0.3 to (V <sub>CC</sub> + 0.3)	V
I <sub>LX</sub>	Switching peak current	2	A
I <sub>REF</sub>	Reference current	2.5	mA
P <sub>TOT</sub>	Continuous power dissipation at $T_A = 70^{\circ}C$	344	mW
T <sub>stg</sub>	Storage temperature range	-40 to +150	°C
T <sub>op</sub>	Operating junction temperature range	0 to +70	°C

#### Table 2. Absolute maximum ratings

*Note:* Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied

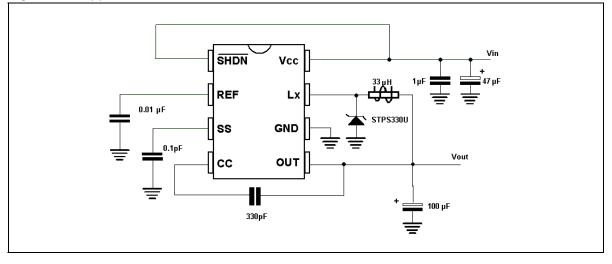
#### Table 3. Thermal data

Symbol	Parameter	SO-8	Unit
R <sub>thJA</sub>	Thermal resistance junction-ambient <sup>(1)</sup>	160	°C/W

1. This value depends from thermal design of PCB on which the device is mounted.

## 4 Typical application

### Figure 3. Application circuit



## 5 Electrical characteristics

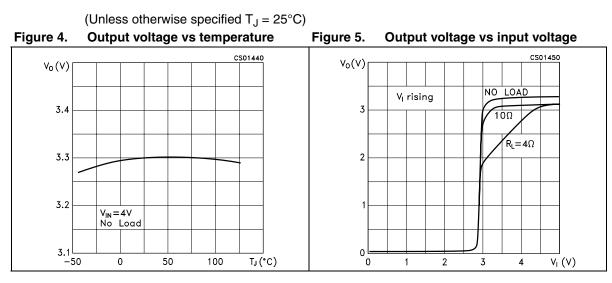
### Table 4. Electrical characteristics

(V\_{CC} = 5V, I\_O = 0mA, T\_A = T\_{MIN} to  $T_{MAX}$ , unless otherwise specified).

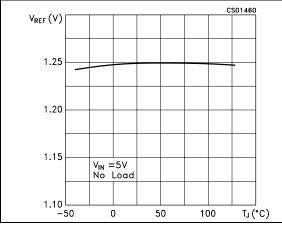
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
V <sub>CC</sub>	Input voltage		3.3		11	V	
V	Output voltage	$V_{CC} = 4$ to 11V, $I_{O} = 0$ to 300mA	3.135	3.3	3.465	V	
Vo	Oulput voltage	$V_{CC} = 4.75$ to 11V, $I_{O} = 0$ to 500mA	3.135	3.3	3.465	V	
$\Delta V_{O}$	Line regulation			0.13		%/V	
$\Delta V_O$	Load regulation	I <sub>O</sub> = 0 to 500mA		0.005		%/mA	
n	Dower officionay	I <sub>O</sub> = 300mA	88		0/		
η	Power efficiency	I <sub>O</sub> = 100mA		90		%	
	Supply ourrent	ON Mode (Including switch current)		0.6	2.5	mA	
I <sub>SUPPLY</sub>	Supply current	OFF Mode		0.2	100	μA	
V <sub>IH</sub>	SHDN Input high threshold		2			V	
V <sub>IL</sub>	SHDN Input low threshold				0.25	V	
I <sub>SHDN</sub>	Shutdown input leakage current				1	μA	
V <sub>LOCK</sub>	Under voltage lockout	V <sub>CC</sub> Falling		2.7	3	V	
R <sub>DS(on)</sub>	LX On resistance	I <sub>LX</sub> = 500mA		1		Ω	
I <sub>LEAK</sub>	LX Leakage current	$V_{CC} = 12V, V_{LX} = 0V$		10		nA	
V <sub>REF</sub>	Reference voltage	$T_A = 25^{\circ}C$	1.18	1.25	1.32	V	
$\Delta V_{REF}$	Temperature reference drift	$T_A = T_{MIN}$ to $T_{MAX}$		50		ppm/°C	
f <sub>OSC</sub>	Switching frequency	$T_A = 25^{\circ}C$	159	200	212.5	KHz	
R <sub>C</sub>	Compensation pin impedance			7500		Ω	

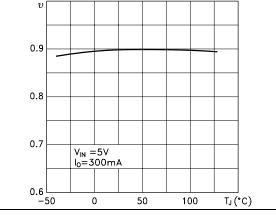
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## 6 Typical performance characteristics











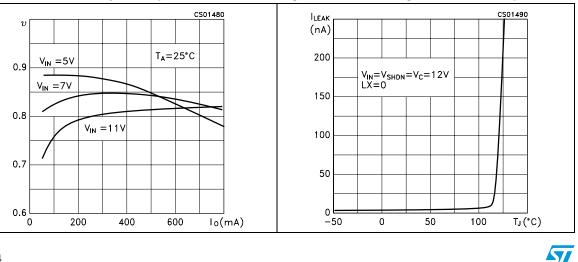


Figure 9. LX leakage current vs temperature



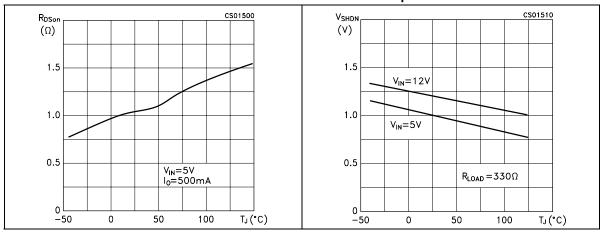


Figure 10. LX ON Resistance vs temperature

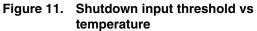


Figure 12. Shutdown input leakage current vs Figure 13. Oscillator frequency vs temperature temperature

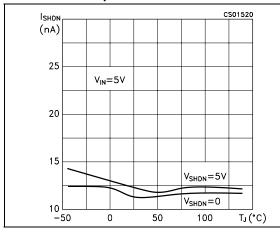
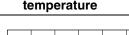


Figure 14. Oscillator frequency vs input voltage



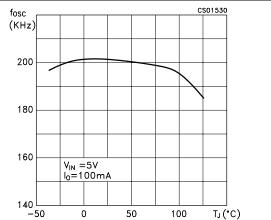
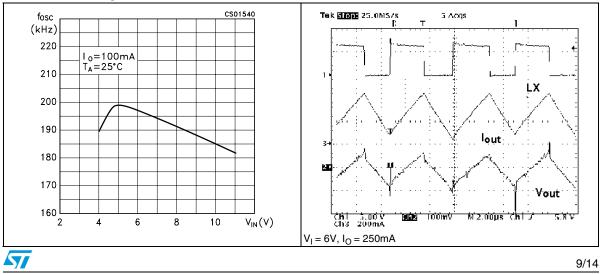


Figure 15. Switching waveform, continuous conduction

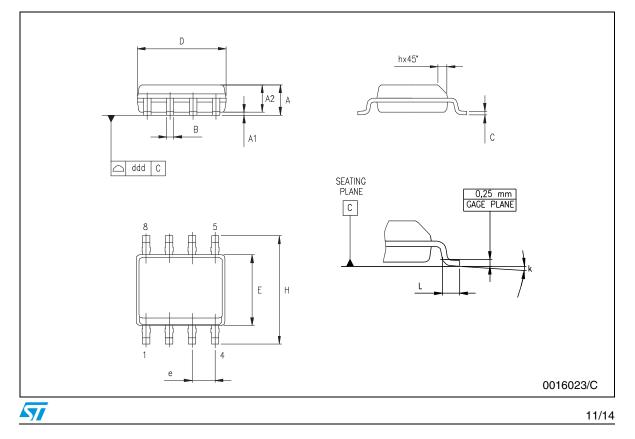


### 7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK<sup>®</sup> packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.



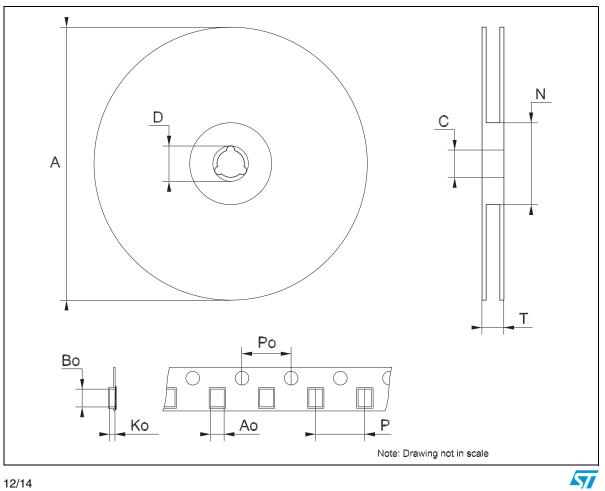
DIM.		mm.		inch		
	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
А	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
В	0.33		0.51	0.013		0.020
С	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
Е	3.80		4.00	0.150		0.157
е		1.27			0.050	
Н	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k			8° (max.)			



### **SO-8 MECHANICAL DATA**

5.1.4		mm.			inch			
DIM.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.		
А			330			12.992		
С	12.8		13.2	0.504		0.519		
D	20.2			0.795				
Ν	60			2.362				
Т			22.4			0.882		
Ao	8.1		8.5	0.319		0.335		
Во	5.5		5.9	0.216		0.232		
Ko	2.1		2.3	0.082		0.090		
Po	3.9		4.1	0.153		0.161		
Р	7.9		8.1	0.311		0.319		





## 8 Revision history

Table 5.Revision history

Date	Revision	Changes
26-May-2006	2	Add $T_A$ row $f_{OSC}$ on table 4 and new template.
29-May-2007	3	Order code has been updated.

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